



51762

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	William T. Chen)	Group Art No.:	1762
Application No:	10/029,435)	Examiner:	Padgett, Marianne L.
Filed:	12/18/2001)	Re:	RESPONSE
For:	"Method of Forming Selective Electroless Plating on Polymer Surfaces")	Our Ref:	B-4361 619261-9
)	Date:	July 7, 2003

Commissioner for Patents
POB 1450
Alexandria, VA 22313-1450

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JUL 15 2003
TC 1700

Dear Sir:

This paper is filed in response to the official action dated June 12, 2003.

Applicant elects Group I (Claims 1-17) to be examined first in this application.

The Commissioner is authorized to charge any additional fees which may be required or credit overpayment to deposit account no. 12-0415. In particular, if this response is not timely filed, then the Commissioner is authorized to treat this response as including a petition to extend the time period pursuant to 37 CFR 1.136 (a) requesting an extension of time of the number of months necessary to make this response timely filed and the petition fee due in connection therewith may be charged to deposit account no. 12-0415.

I hereby certify that this correspondence is being deposited with the
United States Post Office with sufficient postage as first class mail in an
envelope addressed to Commissioner for Patents

POB 1450, Alexandria, VA 22313-1450 on

July 7, 2003

(Date of Deposit)

Corinda Humphrey


(Name of Person Signing)

(Signature)

July 7, 2003

(Date)

Respectfully submitted,



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